# 2SB1219, 2SB1219A

## Silicon PNP epitaxial planar type

For general amplification

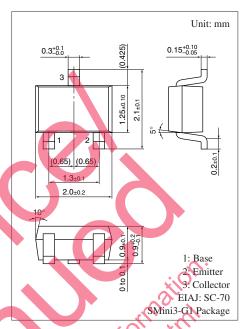
Complementary to 2SD1820 and 2SD1820A

#### ■ Features

- ullet Large collector current  $I_C$
- S-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage	2SB1219	V <sub>CBO</sub>	-30	V
(Emitter open)	2SB1219A		-60	
Collector-emitter voltage	2SB1219	V <sub>CEO</sub>	-25	V
(Base open)	2SB1219A		-50	
Emitter-base voltage (Col	$V_{EBO}$	-5	V	
Collector current		$I_C$	-500	mA
Peak collector current	$I_{CP}$	-1	A	
Collector power dissipation		Pc	150	mW
Junction temperature		T <sub>j</sub>	150	°C
Storage temperature		T <sub>stg</sub>	-55 to +150	°C



### Marking Symbol:

- 2SB1219: C
- 2SB1219A.I

## ■ Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage 2SB1219	V <sub>CBO</sub>	$I_{\rm C} = -10  \mu A, I_{\rm E} = 0$	-30			V
(Emitter open) 2SB1219A		1215	-60			
Collector-emitter voltage 2SB1219	V <sub>CEO</sub>	$I_{\rm C} = -2 \text{ mA}, I_{\rm B} = 0$	-25			V
(Base open) 2SB1219A		"Und Co.,	-50			
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_{\rm E} = -10  {\rm pA}, I_{\rm C} = 0$	-5			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = -20 \text{ V} \cdot I_{E} = 0$			- 0.1	μΑ
Forward current transfer ratio *1	h <sub>FE1</sub> *2	$V_{CE} = -10 \text{ V}, I_{C} = -150 \text{ mA}$	85		340	
	h <sub>FE2</sub>	$V_{CE} = 10 \text{ V}, I_{C} = -500 \text{ mA}$	40			
Collector-emitter saturation voltage *1	VE(sat)	$I_C = -300 \text{ mA}, I_B = -30 \text{ mA}$		- 0.35	- 0.60	V
Base-emitter saturation voltage *1	V <sub>BE(sat)</sub>	$I_{\rm C} = -300 \text{ mA}, I_{\rm B} = -30 \text{ mA}$		-1.1	-1.5	V
Transition frequency	Y <sub>T</sub>	$V_{CB} = -10 \text{ V}, I_E = 50 \text{ mA}, f = 200 \text{ MHz}$		200		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		6	15	pF
(Common base, input open circuited)						

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

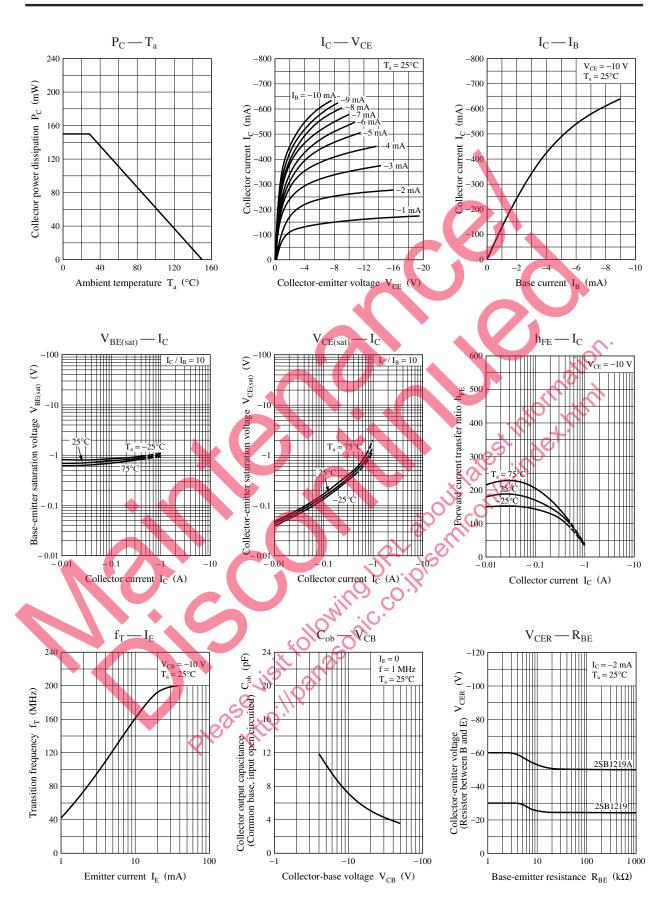
#### 2. \*1: Pulse measurement

#### \*2: Rank classification

Ra	ank	Q	R	S	No-rank
h <sub>l</sub>	FE1	85 to 170	120 to 240	170 to 340	85 to 340
Marking	2SB1219	CQ	CR	CS	С
symbol	2SB1219A	DQ	DR	DS	D

Note) Product of no-rank is not classified and have no marking symbol for rank.

## **Panasonic**



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